

HA-5152/883

Dual, Low Power January 1989 Operational Amplifier

Features

- This Circuit is Processed in Accordance to Mil-Std-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- Low Supply Current (Both Amplifiers) 500μA (Max)
- Wide Supply Voltage Range...... Single 3V to 30V or Dual ±1.5 to ±15V
- High Slew Rate +S.R. 4V/us (Min) 6V/μs (Typ)
- Low Vos Drift (Over Full Temp) 3μV/°C (Typ)
- Low Noise (1kHz)...... 15nV/√Hz (Typ)
- 100% Tested at ±15V and +5V Power Supplies
- Dielectric Isolation

Applications

- · Portable Instruments
- Meter Amplifiers
- Telephone Headsets
- Microphone Amplifiers
- Remote Sensor/Transmitter
- Battery Powered Equipment
- For Further Design Ideas See App. Note 544

Description

The HA-5152/883 dual operational amplifier is part of a family of dielectrically isolated bipolar amplifiers designed to provide excellent AC performance while drawing less than 250µA of supply current per amplifier at +25°C. This series consists of single (5151), dual (5152) or quad (5154), unity gain stable amplifiers which are especially well suited for portable and lightweight equipment where available power is limited.

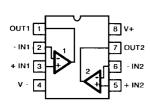
The HA-5152/883 combines superior low power AC performance with DC precision not usually found in general purpose amplifiers. The DC performance is centered around low input offset voltage (3mV), low offset voltage drift (3µV/OC), and low input bias current (250nA). This is combined with a very low input noise voltage of 15nV/\(\sqrt{Hz}\) at 1kHz.

The AC performance of the HA-5152/883 surpasses that of typical low power amplifiers with 4V/us slew rate and a full power bandwidth of 64kHz. This makes the HA-5152/883 an excellent choice for virtually all audio processing applications as well as remote sensor/ transmitter designs requiring both low power and high speed. The suitability of the HA-5152/883 for remote and low power operation is further enhanced by the wide range of supply voltages (±1.5V to ±15V) as well as single supply operation (3V to 30V).

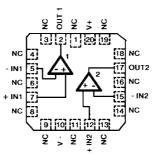
The HA-5152/883 is available in 8 pin Ceramic Mini-DIP. 20 pad Ceramic LCC or 8 pin (TO-99) Metal Can, and is interchangeable with most other operational amplifiers in their class.

Pinouts

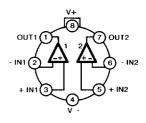
HA7-5152/883 (CERAMIC MINI-DIP) TOP VIEW



HA4-5152/883 (CERAMIC LCC) TOP VIEW



HA2-5152/883 (METAL CAN) TOP VIEW



Specifications HA-5152/883

Absolute Maximum Ratings	Thermal Information		
Voltage Between V+ and V- Terminals	Thermal Resistance Ceramic DIP Package Ceramic LCC Package Metal Can Package Package Power Dissipation Limit at +75°C		^θ jc 26°C/W 20°C/W 35°C/W 175°C
One Amplifier Shorted to Ground Junction Temperature (T _J) +175°C Storage Temperature Range65°C to +150°C ESD Rating <2000V Lead Temperature (Soldering 10 sec) +275°C CAUTION: Absolute maximum ratings are limiting values, applied individually beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.	Ceramic DIP Package Ceramic LCC Package Metal Can Package Package Power Dissipation Derating Factor Ceramic DIP Package Ceramic LCC Package Metal Can Package	Above +75'	1.35W 900mW °C 2.2mW/°C 3.5mW/°C

Recommended Operating Conditions

TABLE 1. D.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: $R_{SOURCE} = 100\Omega$, $R_{LOAD} = 500k\Omega$, $V_{OUT} = 0V$, Unless Otherwise Specified. Subscript 1 Refers to Supply Voltages ($\pm V_S$) = $\pm 15V$, Subscript 2 Refers to $\pm V_S = 5.0V$, $\pm V_S = 0.0V$.

			GROUP A		LIMITS		
D.C. PARAMETERS	SYMBOL	CONDITIONS	SUBGROUP TEMPERATURE		MIN	MAX	UNITS
Input Offset Voltage	V _{IO1}	V _{CM} = 0V	1	+25°C	-3	3	mV
			2,3	+125°C,-55°C	-4	4	mV
	V _{IO2}		1	+25°C	-3	3	mV
		V _{OUT} = 1.4V	2,3	+125°C, -55°C	-4	4	mV
Input Bias Current	+l _{B1}	V _{CM} = 0V	1	+25°C	-250	250	nA
		$+R_S = 10k\Omega$ $-R_S = 100\Omega$	2,3	+125°C, -55°C	-400	400	nA
	-I _{B1}	V _{CM} = 0V	1	+25°C	-250	250	nA
		$+R_S = 100\Omega$ $-R_S = 10k\Omega$	2,3	+125°C, -55°C	-400	400	nA
	$^{+1}$ B2 V CM = 0V, V OUT = 1.4V $^{+}$ RS = 10kΩ $^{-}$ RS = 100Ω	1	+25°C	-250	250	nA	
		2,3	+125°C, -55°C	-400	400	nA	
	$^{-1}B2$ $V_{CM} = 0V, V_{OUT} = 1.4V$ $+R_S = 100\Omega$ $-R_S = 10k\Omega$	1	+25°C	-250	250	nA	
		2,3	+125°C, -55°C	-400	400	nA	
Input Offset Current	101	I _{IO1} V _{CM} = 0V +R _S = 10kΩ -R _S = 10kΩ	1	+25°C	-50	50	nA.
			2,3	+125°C, -55°C	-80	80	nA
	I _{O2} V _{CM} = 0V, V _{OUT} = 1.4V	1	+25°C	-50	50	nA	
		$+R_S = 10k\Omega$ $-R_S = 10k\Omega$	2,3	+125°C, -55°C	-80	80	nA
Common Mode Range	+CMR ₁	+CMR ₁ V+ = 5V V- = -25V	1	+25°C	10	-	V
	:		2,3	+125°C, -55°C	10	-	V
	-CMR ₁		1	+25°C	-	-10	٧
		V- = -5V	2,3	+125°C, -55°C	,	-10	>
	+CMR ₂	V+ = 5V to 2V V- = 0V to -3V	1	+25°C	0 to 3	-	٧
		V- = 0V 16 -3V V _{OUT} = 1.4V to -1.6V	2,3	+125°C, -55°C	0 to 3	-	v

CAUTION: This device is sensitive to electrostatic discharge. Proper I.C. handling procedures should be followed.

TABLE 1. D.C. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Tested at: $R_{SOURCE} = 100\Omega$, $R_{LOAD} = 500k\Omega$, $V_{OUT} = 0V$, Unless Otherwise Specified. Subscript 1 Refers to Supply Voltages ($\pm V_S$) = $\pm 15V$; Subscript 2 Refers to $\pm V_S = 5.0V$, $\pm V_S = 0.0V$.

			GROUP A	l	LIM	ITS	
D.C. PARAMETERS	SYMBOL	CONDITIONS	SUBGROUP	TEMPERATURE	MIN	MAX	UNITS
Large Signal Voltae Gain	+AVOL1	V _{OUT} = 0V and 10V	4	+25°C	50	-	kV/V
		$R_L = 10k\Omega$	5, 6	+125°C, -55°C	25	-	kV/V
	-A _{VOL1} V _{OUT} = 0V and -10V		4	+25°C	50	-	kV/V
		R _L = 10kΩ	5, 6	+125°C,-55°C	25	-	kV/V
	+AVOL2	V _{OUT} = 1.4V and 2.5V	4	+25°C	50	-	kV/V
	$R_L = 10k\Omega$	5, 6	+125°C,-55°C	25	-	kV/V	
Common Mode Rejection Ratio	+CMRR ₁	1	+25 ⁰ C	80	-	dB	
riejouoririauo		-V = -25V V _{OUT} = -10V	2, 3	+125°C, -55°C	80	-	dB
	-CMRR ₁		1	+25°C	80	-	dB
		+V = 25V -V = -5V V _{OUT} = 10V	2,3	+125°C, -55°C	80	-	dB
	+CMRR ₂	$\Delta V_{CM} = 0V \text{ to } 3V$	1	+25°C	80	-	dB
		+V = 2V -V = -3V V _{OUT} = -3V	2,3	+125°C, -55°C	80	-	dB
Output Voltage Swing	+VOUT1	R _L = 10kΩ	1	+25°C	10	-	V
			2,3	+125°C, -55°C	10	-	V
	-V _{OUT1} R _L = 10kΩ	R _L = 10kΩ	1	+25°C	-	-10	v
			2,3	+125°C, -55°C	-	-10	V
	$+V_{OUT2}$ R _L = $10k\Omega$		1	+25°C	3.2	-	V
		Terminated at 2.5V	2,3	+125°C, -55°C	2.9	-	V
	-V _{OUT2} R _L = 10kΩ		1	+25°C	-	1	V
		Terminated at 2.5V	2,3	+125°C, -55°C	-	1.2	V
Quiescent Power Supply	+I _{CC1} V _{OUT} = 0V		1	+25°C	-	500	μA
Current (Both Amplifiers)		IOUT = 0mA	2, 3	+125°C, -55°C	-	650	μА
	-ICC1	V _{OUT} = 0V	1	+25°C	-500	-	μА
		IOUT = 0mA	2,3	+125°C,-55°C	-650	-	μА
	+lCC2	V _{OUT} = 1.4V	1	+25°C	-	500	μА
		IOUT = 0mA	2,3	+125°C,-55°C	-	650	μА
Power Supply Rejection Ratio	+PSRR ₁	ΔV _{SUP} = 10V +V = 10V, -V = -15V	1	+25°C	80	-	dB
,	[+V = 20V, -V = -15V	2, 3	+125°C, -55°C	80	-	dB
	-PSRR ₁ ΔV _{SUP} = 10V	1	+25°C	80	-	dB	
		+V = 15V, -V = -10V +V = 15V, -V = -20V	2,3	+125°C, -55°C	80	-	dB
	+PSRR ₂ $\Delta V_{SUP} = 10V$		1	+25°C	80	-	dВ
		+V = 5V, -V = 0V +V = 15V, -V = 0V	2,3	+125°C, -55°C	80	-	dB
Channel Separation	±CS	R _L = 10kΩ	1	+25°C	80	-	dB
			2,3	+125°C,-55°C	80	-	dB

TABLE 2. A.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: $R_{SOURCE} = 50\Omega$, $R_{LOAD} = 10k\Omega$, $C_{LOAD} = 100pF$, $V_{OUT} = 0V$, Unless Otherwise Specified. Subscript 1 Refers to Supply Voltages ($\pm V_S$) = $\pm 15V$; Subscript 2 Refers to $\pm V_S = 5.0V$, $\pm V_S = 0.0V$.

			GROUP A			ITS	
PARAMETERS	SYMBOL	CONDITIONS	SUBGROUP	TEMPERATURE	MIN	MAX	UNITS
Slew Rate	+SR ₁	V _{OUT} = -3V to 3V V _{IN} S.R. <u>≤</u> 25V/μs	4	+25°C	4	-	V/µs
	-SR ₁	V _{OUT} = 3V to −3V V _{IN} S.R. <u><</u> 25V/µs	4	+25°C	4	-	V/µs
	+SR ₂	V _{OUT} = 0V to 3V V _{IN} S.R. ≤ 25V/µs	4	+25°C	2	_	V/µs
	-SR ₂	V _{OUT} = 3V to 0V V _{IN} S.R. ≤ 25V/µs	4	+25°C	2	-	V/µs

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: $R_{SOURCE} = 50\Omega$, $R_{LOAD} = 10k\Omega$, $C_{LOAD} = 100pF$, $A_V = 1V/V$, Unless Otherwise Specified. Subscript 1 Refers to Supply Voltages ($\pm V_S$) = $\pm 15V$; Subscript 2 Refers to $+V_S = 5.0V$, $-V_S = 0.0V$.

				LIMITS		LIMITS	
PARAMETERS	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	MIN	MAX	UNITS
Gain Bandwidth Product	GBWP	$V_O = 200 \text{mV}, f_O = 10 \text{kHz}$	1	+25°C	0.7	-	MHz
Full Power Bandwidth	FPBW ₁	V _{PEAK} = 10V	1, 2	+25°C	64	_	kHz
	FPBW ₂	VPEAK = 1.1V VRef = 2.5V	1, 2	+25°C	290	-	kHz
Minimum Closed Loop Stable Gain	CLSG	$R_L = 10k\Omega, C_L = 100pF$	1	-55°C to +125°C	1	-	V/V
Quiecent	PC ₁	VOUT = 0V, IOUT = 0mA	1, 3	-55°C to +125°C	_	16.5	mW
Power Consumption	PC ₂	V _{OUT} = 1.4V, I _{OUT} = 0mA	1, 3	-55°C to +125°C	-	2.75	mW

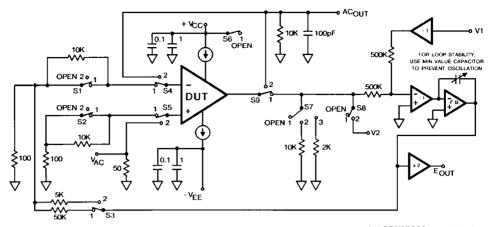
- NOTES: 1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.
 - 2. Full Power Bandwidth guarantee based on Slew Rate measurement using FPBW = Slew Rate/(2πV_{PEAK}).
 - 3. Quiescent Power Consumption based upon Quiescent Supply Current test maximum. (No load on outputs.)

TABLE 4. ELECTRICAL TEST REQUIREMENTS

MIL-STD-883 TEST REQUIREMENTS	SUBGROUPS (SEE TABLES 1 & 2)
Interim Electrical Parameters (Pre Bum-in)	1
Final Electrical Test Parameters	1*, 2, 3, 4, 5, 6
Group A Test Requirements	1, 2, 3, 4, 5, 6
Groups C & D Endpoints	1

^{*} PDA applies to Subgroup 1 only.

Test Circuit (Applies to Tables 1 and 2)



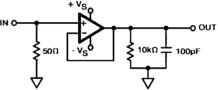
ONE OF TWO TEST LOOPS FOR THE HA - 5152/883

ALL RESISTORS = \pm 1% (Ω) ALL CAPACITORS = \pm 10% (μ F)

For Detailed Information, Refer to HA-5152/883 Test Tech Brief

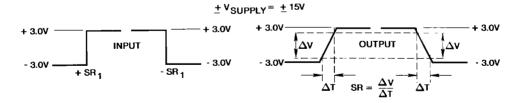
Test Waveforms

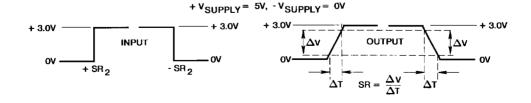
SIMPLIFIED TEST CIRCUIT (Applies to Table 2)

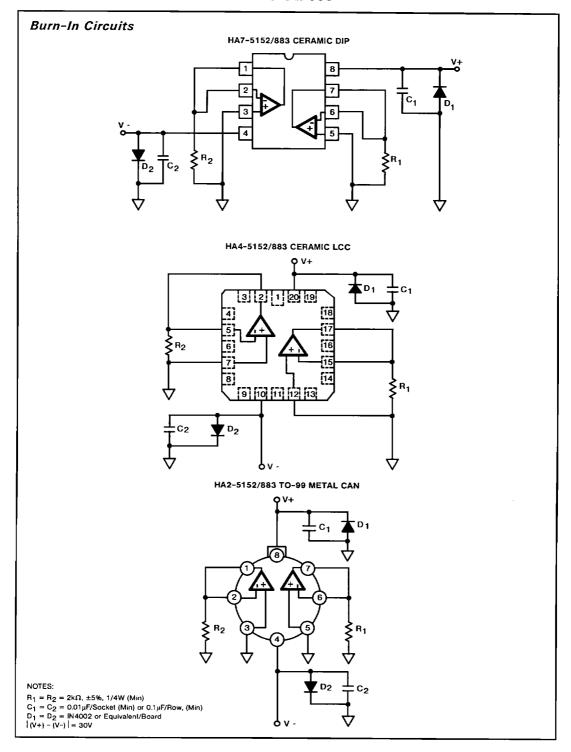


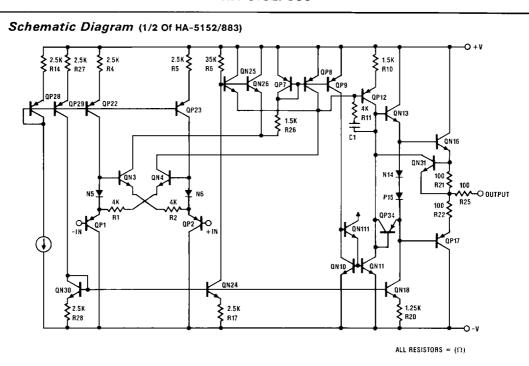
NOTE: ±V_{SUPPLY} (±V_S) Tested with ±15V and 0V, +5V. V_{IN} Siew Rate Maintained with Less Than 10V/µs Input for Voltage Follower Configuration.

SLEW RATE WAVEFORMS, Ay = 1V/V









Die Characteristics

DIE DIMENSIONS:

53.9 x 103.1 x 19 mils (1370 x 2620 x 483 µm)

METALLIZATION:

Type: Aluminum Thickness: 16kÅ ± 2kÅ

WORST CASE CURRENT DENSITY:

0.6 x 10⁵A/cm² @ 2.5mA

SUBSTRATE POTENTIAL (Powered Up): V-

GLASSIVATION:

Type: Nitride

Thickness: 7kÅ ± 0.7kÅ

TRANSISTOR COUNT: 72

PROCESS: HFSB Bipolar/JFET Dielectric Isolation

DIE ATTACH:

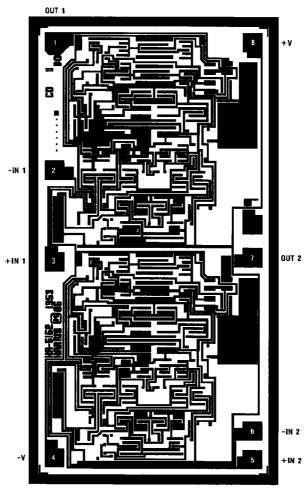
Material: Gold/Silicon Eutectic Alloy

Temperature: Ceramic DIP — 460°C (Max)
Ceramic LCC — 420°C (Max)

Metal Can — 420°C (Max)

Metallization Mask Layout

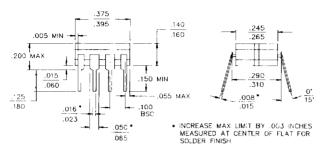
HA-5152/883



NOTE: Pad Numbers Refer to 8 Pin Ceramic Mini-DIP or Metal Can Package Pinouts Only.

Packaging †

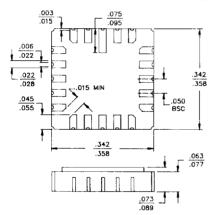
8 PIN CERAMIC DIP



LEAD MATERIAL: Type B
LEAD FINISH: Type A
PACKAGE MATERIAL: Ceramic, 90% Alumina
PACKAGE SEAL:
Material: Glass Frit
. Temperature: 450°C ± 10°C
Method: Furnace Seal
INTERNAL LEAD WIRE:

Material: Aluminum
Diameter: 1.25 Mil
Bonding Method: Ultrasonic
COMPLIANT OUTLINE: 38510 D-4

20 PAD CERAMIC LCC

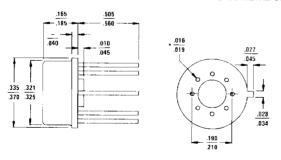


PAD MATERIAL: Type C
PAD FINISH: Type A
FINISH DIMENSION: Type A
PACKAGE MATERIAL: Ceramic, 90% Al₂O₃
PACKAGE SEAL:

Material: Gold/Tin (80/20)
Temperature: 320°C ± 10°C
Method: Furnace Braze
INTERNAL LEAD WIRE:
Material: Aluminum
Diameter: 1.25 Mil

Bonding Method: Ultrasonic COMPLIANT OUTLINE: 38510 C-2

8 PIN TO-99 METAL CAN



*Dimension Maximum Limits Are Increased by 0.003 inches for Solder Dip Finish

LEAD MATERIAL: Type A LEAD FINISH: Type C PACKAGE MATERIAL: Kovar Header with Nickel Can

PACKAGE SEAL:

Material: No Seal Material Temperature: Room Temperature Method: Resistance Weld INTERNAL LEAD WIRE:

Material: Aluminum Diameter: 1.25 Mil

Bonding Method: Ultrasonic Bonded COMPLIANT OUTLINE: 38510 A-1

NOTE: All Dimensions are Min Max . Dimensions are in inches.

† Mil-M-38510 Compliant Materials, Finishes, and Dimensions



HA-5152

DESIGN INFORMATION

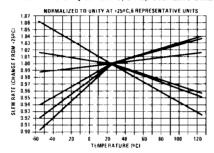
Dual, Low Power Operational Amplifier

The information contained in this section has been developed through characterization by Harris Semiconductor and is for use as application and design aid only. These characteristics are not 100% tested and no product guarantee is implied.

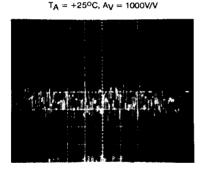
Typical Performance Curves Unless Otherwise Specified: TA = +25°C, VSUPPLY = ±15V

SLEW RATE vs. TEMPERATURE

Normalized to Unity at +25°C, 6 Representative Units

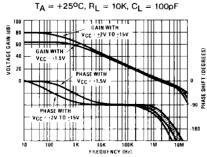


PEAK-TO-PEAK NOISE 0.1Hz TO 10Hz

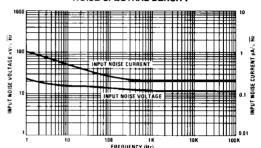


Vertical Scale. (Volts: 100μs/Div.) Horizontal Scale: (Time: 1sec/Div.) 430ηV_{P-P} RTI

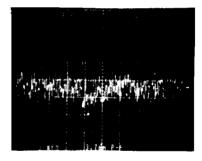
FREQUENCY RESPONSE vs. SUPPLY VOLTAGE



NOISE SPECTRAL DENSITY

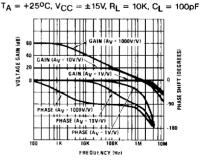


PEAK-TO-PEAK 0.1Hz TO 1MHz $T_A = +25^{\circ}C, A_V = 1000V/V$



Vertical Scale: (Volts: 1mV/Div.) Horizontal Scale: (Time: 1sec/Div.) 3.70μV_{D-D} RTI

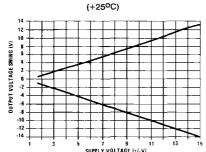
FREQUENCY RESPONSE AT VARIOUS GAINS



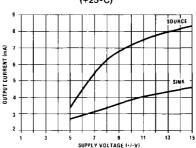
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Typical Performance Curves Unless Otherwise Specified: TA = +25°C, VSUPPLY = ±15V

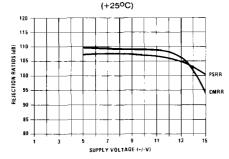
OUTPUT VOLTAGE SWING VS. SUPPLY VOLTAGE



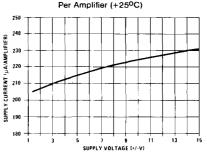
OUTPUT CURRENT vs. SUPPLY VOLTAGE (+25°C)



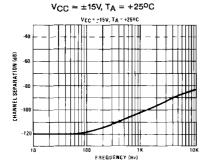
CMRR AND PSRR vs. SUPPLY VOLTAGE



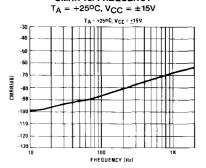
SUPPLY CURRENT vs. SUPPLY VOLTAGE



CHANNEL SEPARATION vs. FREQUENCY



CMRR vs. FREQUENCY

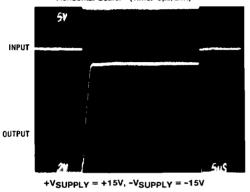


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Typical Performance Curves Unless Otherwise Specified: TA = +25°C, VSUPPLY = ±15V

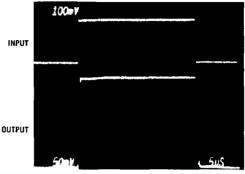
MEASURED LARGE SIGNAL RESPONSE

Vertical Scale: (Volts: Input = 5V/Div.; Output = 2V/Div.) Horizontal Scale: (Time: 5µs/Div.)



MEASURED SMALL SIGNAL RESPONSE

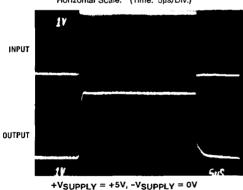
Vertical Scale: (Volts: Input = 100mV/Div.; Output = 50mV/Div.) Horizontal Scale: (Time: 5µs/Div.)



 $+V_{SUPPLY} = +15V, -V_{SUPPLY} = -15V$

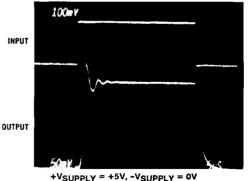
MEASURED LARGE SIGNAL RESPONSE

Vertical Scale: (Volts: Input = 1V/Div.; Output = 1V/Div.) Horizontal Scale: (Time: 5µs/Div.)



MEASURED SMALL SIGNAL RESPONSE

Vertical Scale: (Volts: Input = 100mV/Div.; Output = 50mV/Div.) Horizontal Scale: (Time: 5µs/Div.)



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Typical Applications Unless Otherwise Specified: TA = +25°C, VSUPPLY = ±15V

Independent Amplifier

The HA-5152 dual op amp consist of completely separate amplifier circuits. Unlike most duals, this device does not share a common bias network. Thus, one amplifier passing large, or noisy signals will have minimal effect on another channel carrying small, sensitive signals.

Loading

Although the standard load is $10k\Omega$, the HA-5152 is capable of driving resistive loads down to $2k\Omega$ and capacitive loads beyond 300pF.

Input Stage

This amplifier uses a current amplifying input stage (see Application Note 544) and is not recommended for use in applications which involve large differential input voltages such as open-loop comparators. Most op amp applications use feedback and keep the input terminals at approximately the same voltage. The HA-5152 will perform well in these circuits as long as the input terminals see less than 7 volts differential.

Typical Applications

The low power consumption of the HA-5152 makes it ideal for applications like battery-powered instrumentation where the bridge amplifier circuit below would be used.

Choose a low-current zener voltage reference such as LM285Z-2.5 and select Rp accordingly. This circuit was evaluated using the resistor values shown and a laboratory voltage source for the 2.5V reference. With unmatched, off-the-shelf, 1% resistors, a gain accuracy of 1% to 2% can be expected. Temperature testing indicated a voltage offset tempco of less then 100µV/oC referred to output.

$$V_{OUT} = (V_P - V_N) [2 (1 + \frac{R}{R_G})] + V_R$$
 $R_{R_G} = 1k$
 $V_{R_G} = 10k$
 $V_{R_$

The information contained in this section has been developed through characterization by Harris Semiconductor and is for use as application and design aid only. These characteristics are not 100% tested and no product guarantee is implied.

TYPICAL PERFORMANCE CHARACTERISTICS

Device Characterized at: Supply Voltage = 0V, 5 to ± 15 V, R_L = 10k Ω , C_L = 100pF, Unless Otherwise Specified.

PARAMETERS	CONDITIONS	TEMP	TYPICAL	DESIGN LIMIT	UNITS
Offset Voltage	V _{CM} = 0V	Full	0.5	Table 1	mV
Offset Voltage Drift	Versus Temperature	Full	3	6	μV/°C
Bias Current	V _{CM} = 0V	+25°C, +125°C	130	Table 1	nA
		-55°C	150	Table 1	nA
Offset Current	V _{CM} = 0V	Full	5	Table 1	nA
Differential Input Resistance		+25°C	1.5	1	МΩ
Input Noise Voltage	f _O = 10Hz	+25°C	18	25	nV/√Hz
	f _O = 100Hz	+25°C	15	20	nV/√Hz
	f _O = 1kHz	+25°C	14.8	18	nV/√Hz
Input Noise Current	f _O = 10Hz	+25°C	0.5	0.7	pA/√Hz
	f _O = 100Hz	+25°C	0.3	0.6	pA/√Hz
	f _O = 1kHz	+25°C	0.25	0.4	pA/√Hz
Large Signal Voltage Gain	$R_L = 10k\Omega$	+25°C, +125°C	150K	Table 1	V/V
		-55°C	100K	Table 1	V/V
CMRR		Futl	105	Table 1	dB
PSRR		Full	105	Table 1	dB
Unity Gain Bandwidth	f @ -3dB	+25°C	1.3	0.7	MHz
+ Siew Rate	V _S = 0V, 5V	-55°C	4	2	V/μs
	$V_S = 0V$, 5V to ±15V	+25°C, +125°C	6.5	4	V/µs
- Slew Rate	V _S = 0V, 5V	Full	12	2	V/µs
	V _S = ±15V	Full	25	4	V/µs
+ IOUT		+25°C, +125°C	3	1.5	mA
		-55°C	0.8	0.4	mA
-lout		-55°C, +25°C	-7.5	-6	mA
		+125°C	-4.5	-3.5	mA
Rise Time	$V_S = \pm 15V, V_O = 200mV$	Full	250	500	ns
Fall Time	$V_S = \pm 15V, V_O = -200mV$	-55°C, +25°C	110	300	ns
		+125°C	200	400	ns
Overshoot	$V_S = \pm 15V, V_O = \pm 200 \text{mV}$	Full	2	10	%
Supply Current (All Four Amplifiers)	V _S = 0V, 5V	+25°C	350	Table 1	μА
	V _S = ±15V	+25°C	470	Table 1	μА